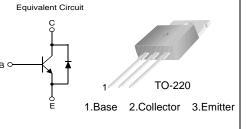
FAIRCHILD

SEMICONDUCTOR

KSC5302D

High Voltage High Speed Power Switch Application

- High Breakdown Voltage : BV_{CBO}=800V
 Built-in Free-wheeling Diode makes efficient anti saturation operation
 Suitable for half bridge light ballast Applications
- No need to interest an h_{FE} value because of low variable storage-time
- spread • Even though corner spirit product
- Low base drive requirement



KSC5302D

NPN Silicon Transistor

Absolute Maximum Ratings T_C=25°C unless otherwise noted

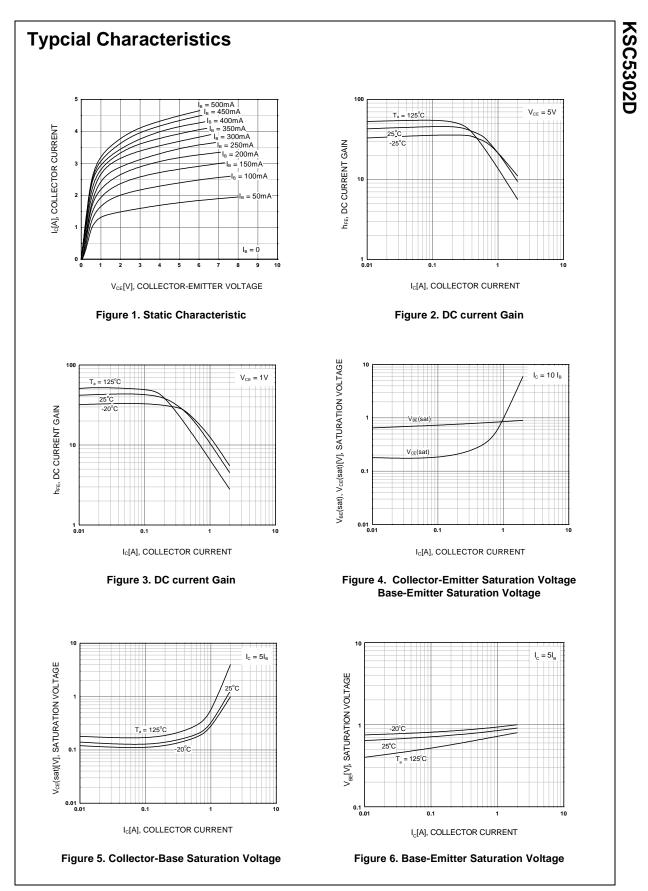
Symbol	Parameter	Value	Units
V _{CBO}	Collector-Base Voltage	800	V
V _{CEO}	Collector-Emitter Voltage	400	V
V _{EBO}	Emitter-Base Voltage	12	V
I _C	Collector Current (DC)	2	А
I _{CP}	*Collector Current (Pulse)	5	А
I _B	Base Current (DC)	1	А
I _{BP}	*Base Current (Pulse)	2	А
Pc	Power Dissipation(T _C =25°C)	50	W
Т _Ј	Junction Temperature	150	°C
Г _{STG}	Storage Temperature	- 55 ~ 150	°C

Thermal Characteristics $T_{C}=25^{\circ}C$ unless otherwise noted

Symbol	Characteristics		Rating	Unit
R _{θjc}	Thermal Resistance	Junction to Case	2.5	°C/W
$R_{\theta ja}$		Junction to Ambient	62.5	

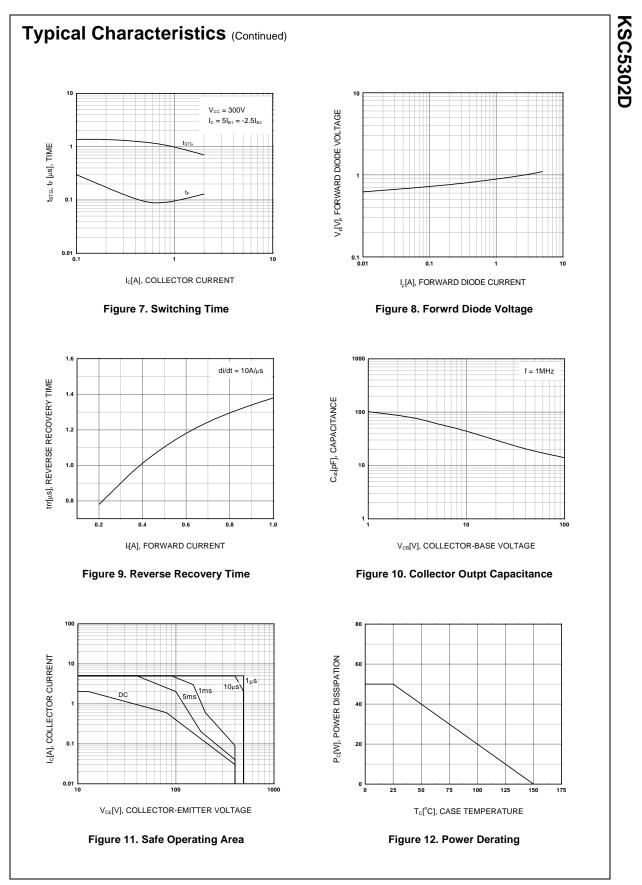
Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV _{CBO}	Collector-Base Breakdown Voltage	I _C =1mA, I _E =0	800	-	-	V
BV _{CEO}	Collector-Emitter Breakdown Voltage	I _C =5mA, I _B =0	400	-	-	V
BV _{EBO}	Emitter Cut-off Current	I _E =1mA, I _C =0	12	-	-	V
I _{CBO}	Collector Cut-off Current	V _{CB} =500V, I _E =0	-	-	10	μΑ
I _{EBO}	Emitter Cut-off Current	$V_{EB} = 9V, I_{C} = 0$	-	-	10	μΑ
h _{FE1} h _{FE2}	DC Current Gain	V _{CE} =1V, I _C =0.4A V _{CE} =1V, I _C =1A	20 10			
V _{CE} (sat)	Collector-Emitter Saturation Voltage	I _C =0.4A, I _B =0.04A I _C =1A, I _B =0.2A	-	-	0.4 0.5	V V
V _{BE} (sat)	Base-Emitter Saturation Voltage	I _C =0.4A, I _B =0.04A I _C =1A, I _B =0.2A	-	-	0.9 1.0	V V
C _{ob}	Output Capacitance	V _{CB} = 10V, f=1MHz	-	-	75	pF
t _{ON}	Turn ON time	V _{CC} =300V, I _C =1A	-	-	150	ns
t _{STG}	Storage Time	Ι _{B1} = 0.2A, Ι _{B2} =-0.5A,	-	-	2	μs
t _F	Fall Time	$R_L = 300\Omega$	-	-	0.2	μs
t _{STG}	Storage Time	V _{CC} =15V, V _Z =300V	-	-	2.35	μs
t _F	Fall Time	$I_{C} = 0.8A, I_{B1} = 0.16A$ $I_{B2} = -0.16A, L = 200\mu H$	-	-	150	ns
V _F	Diode Forward Voltage	I _F = 0.4A I _F = 1A	-	-	1.2 1.5	V V
t _{rr}	*Reverse Recovery Time (di/dt = 10A/μs)	I _F = 0.2A I _F = 0.4A	-	800 1	-	ns μs
		$I_F = 1A$	-	1.4	-	μs

*Pulse Test : Pulse Width=5mS, Duty cycles \leq 10%



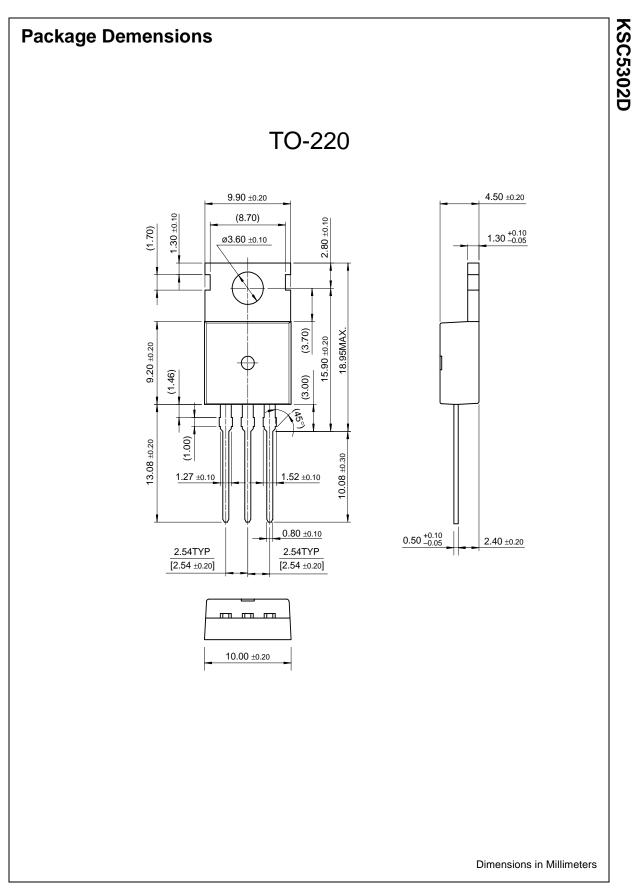
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